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Application number(s) or patent number(s):			
If this document is being filed together with a new application, the A. Patent Application No.(s) NEW, filed March 30, 2005	ne execution date of the application is: March 23, 2005 B. Patent No.(s)		
Additional number			
Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1		
Name: <u>WENDEROTH, LIND & PONACK, L.L.P.</u> <u>Attn: Charles R. Watts , Esq.</u>	7. Total fee (37 CFR 3.41) \$\dot\{40.00}\$		
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PATENT REEL: 016433 FRAME: 0113

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration

Title of

WAFER PROCESSING METHOD

on March 23, 2005

Date of Signing of Application

for which an application for patent in the United States has been executed by the undersigned

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 2033 K Street, N.W., Suite 800, Washington, D.C. 20006-1021, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

PATENT REEL: 016433 FRAME: 0114

	In witness whereof	, executed by the undersign	ned on the date(s) or	pposite the undersigned	1
name Date	• •	05 Name of the Inve		# -% zuhisa ARAI	_
Date ₋		, Name of the Inv	entor		
Date ₋		, Name of the Inve	entor		
Date ₋		, Name of the Inve	entor		
Date ₋		, Name of the Inve	entor		
then t	the execution by the	Should preferably be acknown Inventor(s) should be wither the last of the last	essed by at least two	witnesses who sign he	iot, ;re.)
	Witness	Jun Sakur	rai		

RECORDED: 03/30/2005